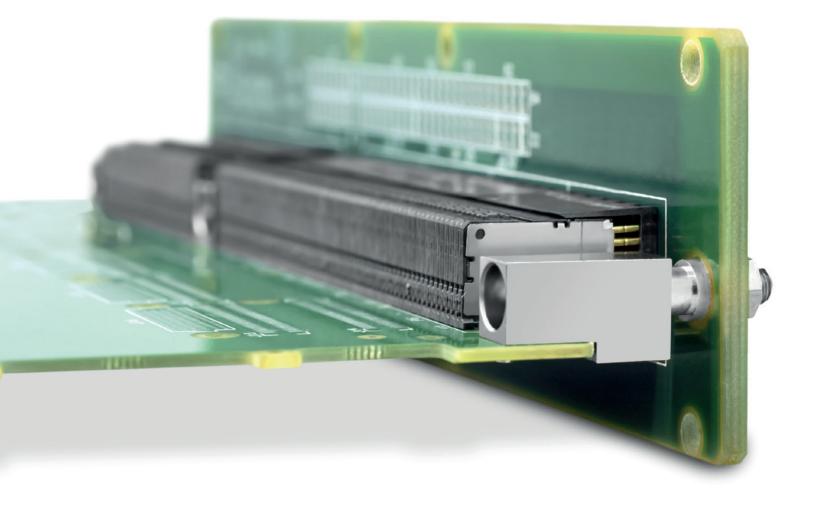
smiths interconnect

KVPX Series

Rugged and high-speed backplane connector system



Technologies

Daughtercard

- KX1HCP02C1TBH: KVPX daughtercard half power module with Sn-Pb press-fit tails
- KX1FCS02C1TBH: KVPX daughtercard full single-ended module with Sn-Pb press-fit tails
- KX1FCD02C1TBH: KVPX daughtercard full differential pair module with Sn-Pb press-fit tails

Backplane

- KX2HCU01C1TAH: KVPX backplane half power module with gold press-fit tails
- KX2FCU01C1TAH: KVPX backplane full universal module with gold press-fit tails

Hypertac[®] contacts

- Immunity to shock and vibration
- Low insertion/extraction forces
- Minimal contact resistance
- Industry leading mating cycles
- Self-clean wipe action for better signal integrity







KVPX Series

Resistant to shock and vibration

High speed up to 16 Gbps

Faceplate to protect daughtercard pins

Smiths Interconnect's KVPX Series is an embedded interconnect system that provides unrivaled performance in harsh environments while adapting to the VITA standard design requirements. By utilizing the Hypertac[®] superior hyperboloid contact technology, the KVPX Series ensures exceptional tolerance to shock and vibration, low insertion forces, high current ratings and the lowest fretting corrosion available.

Fretting corrosion caused by the relative movement of contacts during continual shock and vibration in harsh environments is the leading cause of failure in aerospace, space, and defense systems platforms. This is especially problematic at the backplane interface of embedded computers such as avionics, radar, sensors, motor controls, weapon systems, and space applications such as launchers and satellites.



To solve this problem, Smiths Interconnect has integrated its legendary Hypertac contact system into a VITA 46/48 form factor by evolving its space proven cPCI connector technology. The KVPX interconnect system has been standardized into VITA 63 and meets all of the high-speed electrical requirements of VITA 46/48 while vastly increasing the mechanical reliability and physical ruggedness of unmated connectors and modules.

To that end, the KVPX utilizes a reverse gender versus other backplane connectors, further protecting the male pins from damage. KVPX connectors are qualified to EEE-INST-002 Level 1 and are equipped with Hypertac space-qualified 0.4 mm hyperboloid sockets and provide immunity to shock and vibration fretting, numerous linear paths of contact, low-forces, high mating cycles, and a self-wiping cleaning action that results in consistently better integrity in extreme environments.

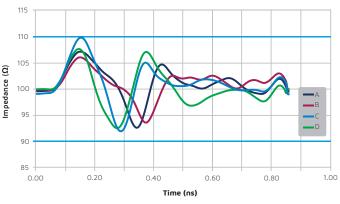
The KVPX Series is highly engineered to guarantee top performance under the most severe condition in demanding applications where failure is not an option.

Technical characteristics

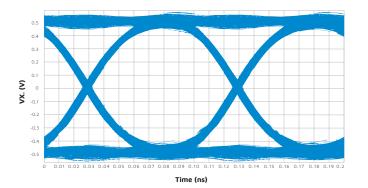
Specifications

- Number of contacts: Half module 72; Full module 144
 Ditabil 9 mm
- Pitch:1.8 mm
- Current rating: 1.5625 A per contact 12.5 A per power wafer (derated using a 30 °C temperature rise and 1 oz copper)
- Extraction force: 1.2 oz per contact typical
- Temperature rating: -55°C to 125°C
- Insulator material: LCP (liquid crystal polymer)
- Contact plating: 50 µin. gold over nickel
- Flammability rating: UL94-VO
- Dielectric withstanding voltage: 500 VAC
- Low-level circuit resistance: 8 mΩ maximum
- Insulation resistance: 500 MΩ maximum
- Random vibration: 15 Grms, 10 Hz to 2000 Hz for 90 min per axis per MIL-STD-1344, Method 2005, Test Condition III
- Mechanical shock: 100 G, 6 ms Sawtooth response per MIL-STD-1344, Method 2004, Test Condition G

Performance



Measured impedance through TDR (50 ps rise time).



 $\label{eq:Eye} \mbox{Eye diagram @10 Gbps.} \\ \mbox{Crosstalk from 6 adjacent channels (NEXT and FEXT).} \\$

Features

- Space qualified to EEE-INST-002 Level 1
- Compatible with VITA 46, 47, 63, and 78 (Space) standards
- Up to 16 Gbps data rate performance
- 100 Ω impedance for differential pair configuration
- Differential, single-ended, and power modules
- 0.56 mm (0.022 in.) diameter via for backplane connector
- Flexible modular design for standard 3U and 6U as well as custom configurations
- Press-fit termination
- Reliable Hypertac hyperboloid contact technology

Speed is another critical factor when comparing VPX connector solutions and as technology evolution continues to push the limits. For system solution providers speed is a critical element in their ability to address the computation and I/O requirements of data driven applications. When evaluating the speed capability of a connector the key factors are impedance, return loss, insertion loss and crosstalk.

The use of impedance-controlled connectors is standard practice in radio frequency applications and is now being utilized for high-speed data transmission. In a transmission line, impedance matching is necessary to minimize reflections, to deliver the correct amplitude signal and to maximize power at the receiving end. To maximize signal performance, it is critical to maintain a differential impedance as close to 100 Ω as possible. The KVPX connector has an impedance variation <10% of the target 100 Ω with a 50 ps rise time (0%, no signal, to 100%, full signal) which is representative of the rise time of a 6 Gbps signal.

Due to the matched impedance profile and low loss performance of KVPX, signals travel with minimal disruption through it. The eye patterns of the intrinsic connector indicates a low amount of jitter and a wide eye opening which indicates that the KVPX connector is more than capable for 16 Gbps data rates. The eye pattern combines the impacts of impedance matching, return loss, insertion loss and crosstalk talk performance to ultimately determine the speed capability of the connector.

How to order

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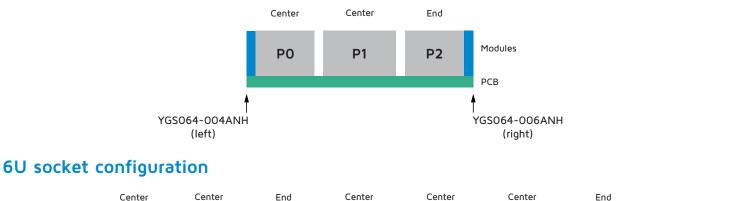
КХ		С	1		-
1 2 3 4	5	6 7	8	9	10
1 KVPX connector series (Fixed)	КХ				
2 Connector type	1 Daughtercard 2 Backplane	Daught	ercard		Backplane
3 Module size	H _{Həlf} F _{Full}	Ha	lf		Full
4 Module style	C Center E End (includes end shield)		End Center P2 P3 Perspective view	Center Cent P4 P5 is looking at the ba	5 P6 Modules PCB
5 Module type	P Power/utility U _{Backplane}	D Differential	pair	S Singl	e ended
6 Module type variant	0 1 Backplane	0	2 Daughter	rcard	
7 Termination style (Fixed)	C Compliant pres	s-fit			
8 Termination length (Fixed)	Daughtercard length 1.8 mm Backplane length 3.3 mm				
9 Termination plating	T B H Tin/lead/gold (daughtercard) T A H Gold (backplane)				
10 Space qualification (Optional)	S L 1 _{Space}	qualified: EEE-INST bank for without s	-002 Level 1 pace qualifica	ation).	

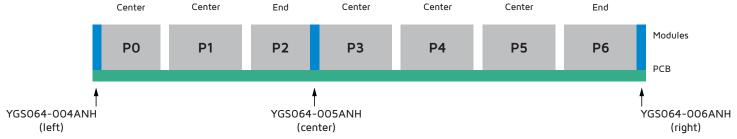
Guide hardware

Pin Part Number	Socket Part Number Description		otion			
	YGS064-004ANH	YGS064-004ANH		Left		
YGP064-001P	YGS064-005ANH	YGS064-005ANH		Center (6U Only)		
	YGS064-006ANH	YGS064-006ANH		Right		
Note For keying options, add a "-" and the number below for keying angle at the end of the part numbers listed above.						
Keying angle	No keying -Omit		3 0°			
	1 90°		4 315°	\bigcirc		
	2 45°	\bigcirc	5 270°			
		nment/keying socket gnment and keying p				

Note Mounting hardware is included with guide hardware.

3U socket configuration





Note Perspective view is looking at the backplane

Installation tooling

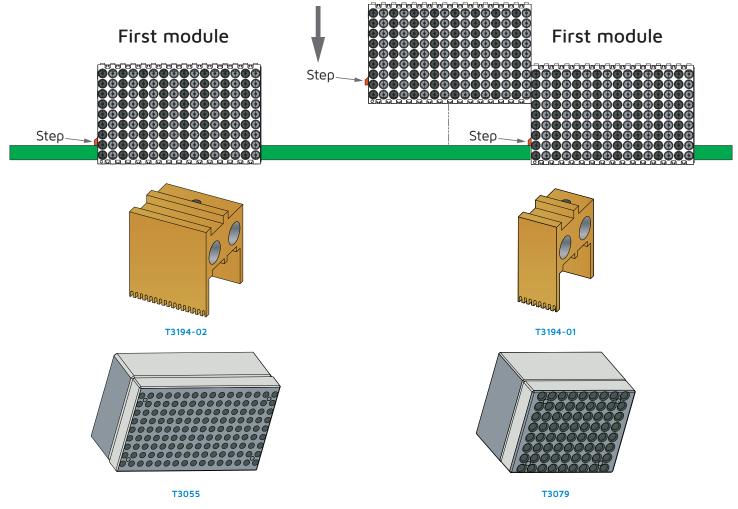
Individual module tools

Part Number	Description	Compatible Modules	
T3194-02	Daughtercard module installation tool, 144-pin*	KX1FCD02C1TBH	
		KX1FED02C1TBH	
		KX1FCS02C1TBH	
		KX1FES02C1TBH	
		KX1FCP02C1THB	
		KX1FCH02C1THB	
T3194-01	Daughtersard medule jostallation tool 70 eis*	KX1HCP02C1TBH	
	Daughtercard module installation tool, 72-pin*	KX1HEP02C1TBH	
Т3055	Backplane module installation tool, 144-socket**	KX2FCU01C1TAH	
T3079	Backplane module installation tool, 72-socket**	КХ2НСU01С1ТАН	

* Only to be used with single module applications.

** For applications with adjacent module it is necessary to ensure that the first module is installed with the plastic "step" on the inboard side of the connector. All adjacent modules are to be installed in order following the same rule. See below:

Second module

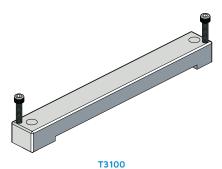


smiths interconnect

3U/6U tools

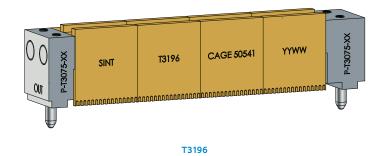
Part Number	Description
Т3099	3U installation tool, backplane modules
T3099 & T3100	6U installation tools, backplane modules
T3197	3U installation tool, daughtercard module
T3197 & T3196	6U installation tools, daughtercard module





CAGE 50541 YWW 1000

T3197



Disclaimer

All of the information included in this catalogue is believed to be accurate at the time of printing. It is recommended, however, that users should independently evaluate the suitability of each product for their intended application and be sure that each product is properly installed, used and maintained to achieve desired results.

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INTERNATIONAL, ALASKA & HAWAII

Please contact one of the ISRs.

Courtney Darrah Inside Sales Representative cdarrah@keiconn.com 512-339-3324

Erin Gagne Inside Sales Representative egagne@keiconn.com 512-339-3331

Kevin Kientopf Inside Sales Representative kkientopf@keiconn.com 512-339-3315

Gabby Bozeman Inside Sales Representative gbozeman@keiconn.com 512-339-3325

John Davis Inside Sales Representative jdavis@keiconn.com 512-339-3311

> Erin Gagne Inside Sales Representative egagne@keiconn.com 512-339-3331

Courtney Darrah Inside Sales Representative cdarrah@keiconn.com 512-339-3324

John Davis

Inside Sales Representative jdavis@keiconn.com 512-339-3311

Gabby Bozeman Inside Sales Representative

gbozeman@keiconn.com 512-339-3325 Kevin Kientopf

Inside Sales Representative kkientopf@keiconn.com 512-339-3315

Scott Kirchmeier

Regional Sales Manager sales@keiconn.com 619-247-0736 (M) 512-339-3312 (O)

North American Sales Support Coverage

